ON Semiconductor

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NPN Silicon Power Transistor

High Voltage Switch-mode Series

Designed for use in electronic ballast (light ballast) and in switch-mode power supplies up to 50 W.

Features

- Improved Efficiency Due to:
 - ◆ Low Base Drive Requirements (High and Flat DC Current Gain h_{FE})
 - ◆ Low Power Losses (On-State and Switching Operations)
 - Fast Switching: $t_{fi} = 100 \text{ ns (typ)}$ and $t_{si} = 3.2 \mu \text{s (typ)}$
 - @ $I_C = 2.0 \text{ A}$, $I_{B1} = I_{B2} = 0.4 \text{ A}$
- Full Characterization at 125°C
- Tight Parametric Distributions Consistent Lot-to-Lot
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Sustaining Voltage	V _{CEO}	400	Vdc
Collector-Base Breakdown Voltage	V _{CES}	700	Vdc
Emitter-Base Voltage	V _{EBO}	9.0	Vdc
Collector Current - Continuous - Peak (Note 1)	I _C	5.0 10	Adc
Base Current	Ι _Β	2.0	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	75 0.6	W W/°C
Operating and Storage Temperature	T _J , T _{stg}	-65 to 150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.65	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

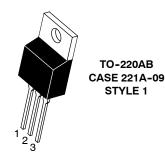
Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.



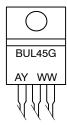
ON Semiconductor®

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POWER TRANSISTOR 5.0 AMPERES, 700 VOLTS, 35 AND 75 WATTS



MARKING DIAGRAM



BUL45 = Device Code A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
BUL45G	TO-220 (Pb-Free)	50 Units / Rail

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic				Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS								
Collector-Emitter Sustaining Vo	V _{CEO(sus)}	400	-	-	Vdc			
Collector Cutoff Current (V _{CE} =	Rated V _{CEO} , I _B = 0))		I _{CEO}	-	-	100	μAdc
Collector Cutoff Current (V _{CE} =	Rated V _{CES} , V _{ER} =		°C)	I _{CES}	-	-	10	μAdc
Emitter Cutoff Current (V _{EB} = 9.		(IC = 125	. ()	Ieno	-	-	100	μAdc
ON CHARACTERISTICS	0 vac, 10 = 0)			I _{EBO}			100	μλασ
Base-Emitter Saturation Voltage	 e			V _{BE(sat)}				Vdc
$(I_C = 1.0 \text{ Adc}, I_B = 0.2 \text{ Adc})$ $(I_C = 2.0 \text{ Adc}, I_B = 0.4 \text{ Adc})$)			• BE(Sat)	-	0.84 0.89	1.2 1.25	l vas
Collector-Emitter Saturation Vo		I _B = 0.2 A (T _C = 125		V _{CE(sat)}	-	0.175 0.150	0.25	Vdc
Collector-Emitter Saturation Vo	Itage (I _C = 2.0 Adc,	I _B = 0.4 A	Adc)	V _{CE(sat)}	-	0.25	0.4	Vdc
		$T_{\rm C} = 125$	°C)		-	0.275	-	
DC Current Gain (I _C = 0.3 Adc,	V _{CE} = 5.0 Vdc)	(T _C = 125	°C)	h _{FE}	14	32	34	-
$(I_C = 2.0 \text{ Adc}, V_{CE} = 1.0 \text{ Vol})$	dc)				7.0	14	-	
(I _C = 10 mAdc, V _{CE} = 5.0 \		$T_{\rm C} = 125$	°C)		5.0 10	12 22	-	
					10	22		
Current Gain Bandwidth (In = 0		lo f - 10	MU->\	f_	1	10		N/IU-
Current Gain Bandwidth (I _C = 0.	f _T	-	12	75	MHz			
Output Capacitance (V _{CB} = 10 \	C _{ob}	-	50	75	pF			
Input Capacitance (V _{EB} = 8.0 V	dc)	1	T	C _{ib}	-	920	1200	pF
Dynamic Saturation Voltage: Determined 1.0 μs and 3.0 μs respectively after rising I _{B1} reaches 90% of final I _{B1} (see Figure 18)	$(I_{C} = 1.0 \text{ Adc} \ I_{B1} = 100 \text{ mAdc} \ V_{CC} = 300 \text{ V})$	1.0 μs	(T _C = 125°C)		-	1.75 4.4	-	Vdc
		3.0 μs	(T _C = 125°C)	V _{CE} (Dyn sat)	-	0.5 1.0	-	
	(I _C = 2.0 Adc I _{B1} = 400 mAdc V _{CC} = 300 V)	1.0 μs	(T _C = 125°C)		-	1.85 6.0	-	
		3.0 μs	(T _C = 125°C)	-	-	0.5 1.0	-	
SWITCHING CHARACTERISTI	CS: Resistive Load	1	(10 = 123 0)		_	1.0		
Turn-On Time	(I _C = 2.0 Adc, I _{B1} =		4 Adc	t _{on}	_	75	110	ns
Turr-On Time	Pulse Width = 20 µ		$(T_C = 125^{\circ}C)$	ron	-	120	-	113
Turn-Off Time	Duty Cycle < 20%	Duty Cycle < 20% V _{CC} = 300 V (T _C = 125°C)				2.8 3.5	3.5	μs
SWITCHING CHARACTERISTI	CS: Inductive Load	d (V _{CC} =	15 Vdc, L _C = 200	μH, V _{clamp} = 30	00 Vdc)	1	l	
Fall Time	(I _C = 2.0 Adc, I _{B1} = I _{B2} = 0.4 Adc)			t _{fi}	70	200	170 -	ns
Storage Time	,			t _{si}	2.6	4.2	3.8	μs
Crossover Time			$(T_C = 125^{\circ}C)$	+	_		350	
CIOSSOVEI IIIIE			(T _C = 125°C)	t _c	-	230 400	350	ns
Fall Time	(I _C = 1.0 Adc, I _{B1} = I _{B2} = 0.5 Adc)	dc (T _C = 125°C)	t _{fi}	-	110 100	150 -	ns	
Storage Time		t _{si}	-	1.1 1.5	1.7	μs		
Crossover Time		t _C	-	170 170	250	ns		
Fall Time	(I _C = 2.0 Adc, I _{B1} = I _{B2} = 2.0 Adc)	$(T_C = 125^{\circ}C)$ dc $(T_C = 125^{\circ}C)$	t _{fi}	-	80	120	ns	
Storage Time	, DZ = / (30)	$(T_C = 125^{\circ}C)$	t _{si}	_	0.6	0.9	μS	
	Ī	(10 - 120 0)	*SI		5.5	5.0	μο	

TYPICAL STATIC CHARACTERISTICS

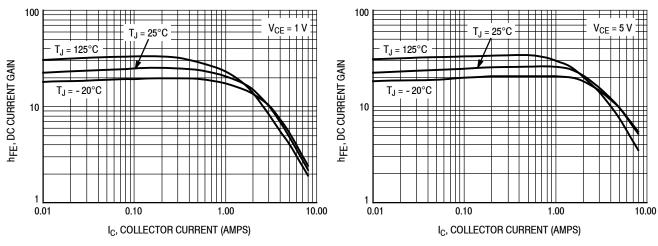


Figure 1. DC Current Gain @ 1 Volt

Figure 2. DC Current Gain at @ 5 Volts

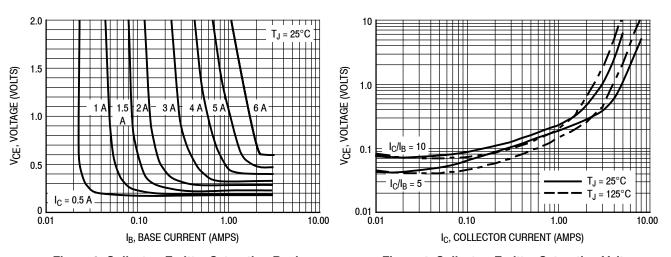


Figure 3. Collector-Emitter Saturation Region

Figure 4. Collector-Emitter Saturation Voltage

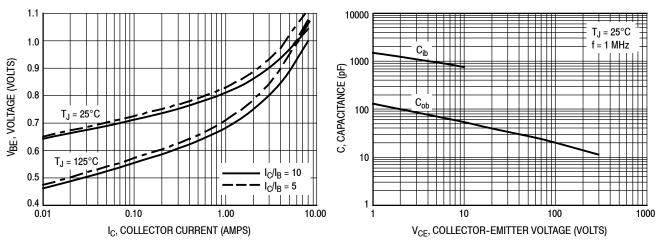


Figure 5. Base-Emitter Saturation Region

Figure 6. Capacitance

TYPICAL SWITCHING CHARACTERISTICS $(I_{B2} = I_C/2 \text{ for all switching})$

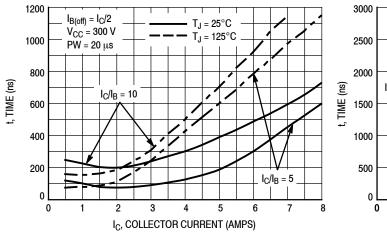
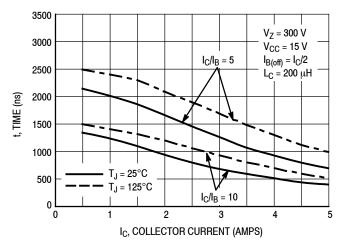


Figure 7. Resistive Switching, ton

Figure 8. Resistive Switching, toff



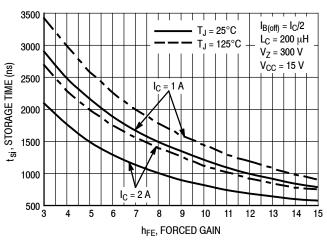
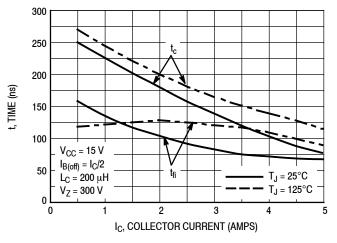


Figure 9. Inductive Storage Time, t_{si}

Figure 10. Inductive Storage Time, tsi(hFE)



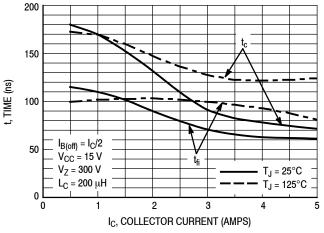


Figure 11. Inductive Switching, t_c & t_{fi} , $I_C/I_B = 5$

Figure 12. Inductive Switching, t_c & t_{fi} , I_C/I_B = 10

TYPICAL SWITCHING CHARACTERISTICS $(I_{B2} = I_C/2 \text{ for all switching})$

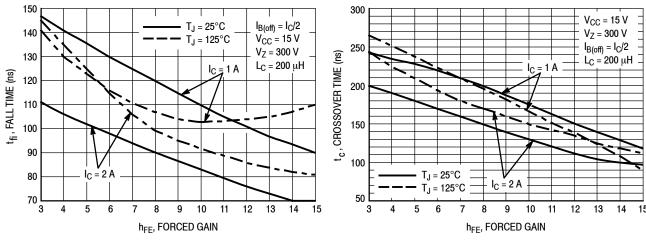


Figure 13. Inductive Fall Time, tfi(hFE)

Figure 14. Crossover Time

GUARANTEED SAFE OPERATING AREA INFORMATION

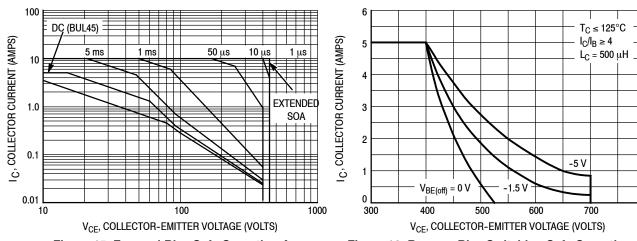


Figure 15. Forward Bias Safe Operating Area

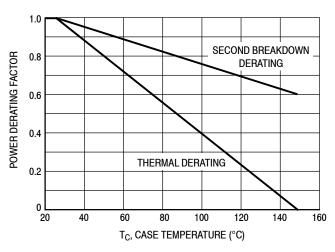
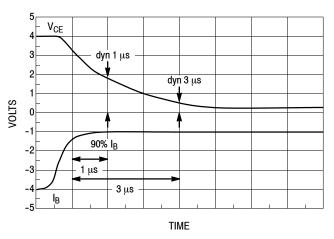


Figure 17. Forward Bias Power Derating

Figure 16. Reverse Bias Switching Safe Operating Area

800

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C - V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 15 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \ge 25$ °C. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown in Figure 15 may be found at any case temperature by using the appropriate curve on Figure 17. T_{J(pk)} may be calculated from the data in Figures 20. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn-off with the base-to-emitter junction reverse-biased. The safe level is specified as a reverse-biased safe operating area (Figure 16). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.



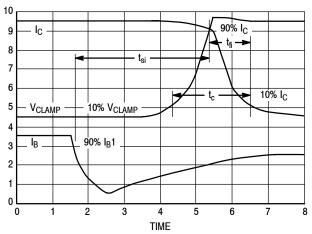


Figure 18. Dynamic Saturation Voltage Measurements

Figure 19. Inductive Switching Measurements

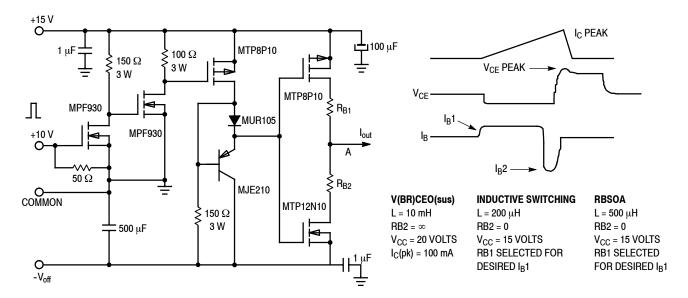


Table 1. Inductive Load Switching Drive Circuit

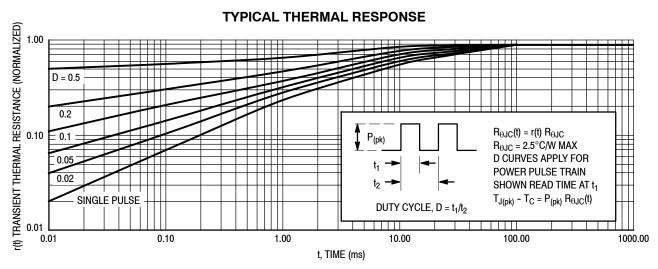
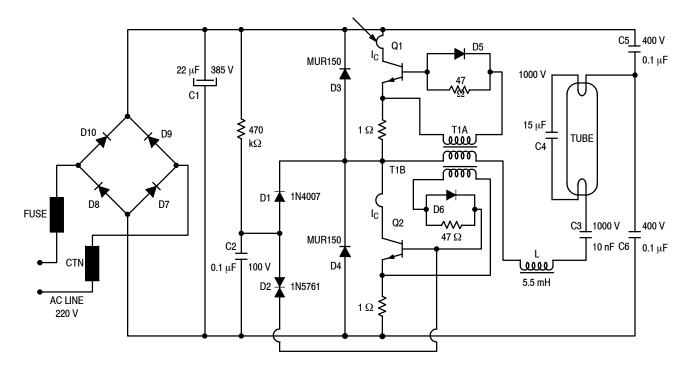


Figure 20. Typical Thermal Response ($Z_{\theta JC}(t)$) for BUL45

The BUL45 Bipolar Power Transistors were specially designed for use in electronic lamp ballasts. A circuit designed by ON Semiconductor applications was built to

demonstrate how well these devices operate. The circuit and detailed component list are provided below.



Components Lists

Q1 =	Q2 = BUL45 Transistor
D1 =	1N4007 Rectifier
D2 =	1N5761 Rectifier
D3 =	D4 = MUR150
D5 =	D6 = MUR105
D7 =	D8 = D9 = D10 = 1N400
CTN =	47 Ω @ 25°C
L =	RM10 core, A1 = 400, B51 (LCC) 75 turns,
	wire $\emptyset = 0.6 \text{ mm}$
T1 =	FT10 toroid, T4A (LCC)

Secondaries: T1A: 4 turns

T1B: 4 turns

Primary: 4 turns

All resistors are 1/4 Watt, ±5%

R1 = $470 \text{ k}\Omega$ R2 = R3 = 47Ω

R4 = R5 = 1 Ω (these resistors are optional, and might be replaced by a short circuit)

C1 = $22 \mu F/385 V$ C2 = $0.1 \mu F$ C3 = 10 nF/1000 V

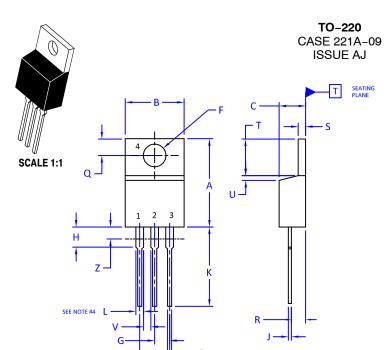
 $\begin{array}{lll} C4 &=& 15 \; nF/1000 \; V \\ C5 &=& C6 = 0.1 \; \mu F/400 \; V \end{array}$

NOTES:

- 1. Since this design does not include the line input filter, it cannot be used "as-is" in a practical industrial circuit.
- 2. The windings are given for a 55 Watt load. For proper operation they must be re-calculated with any other loads.

Figure 21. Application Example





DATE 05 NOV 2019

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCHES		MILLIMI	ETERS
DIM	MIN.	MAX.	MIN.	MAX.
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
К	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:	
PIN 1.	BASE	PIN 1.	BASE	PIN 1.	CATHODE	PIN 1.	MAIN TERMINAL 1
2.	COLLECTOR	2.	EMITTER	2.	ANODE	2.	MAIN TERMINAL 2
3.	EMITTER	3.	COLLECTOR	3.	GATE	3.	GATE
4.	COLLECTOR	4.	EMITTER	4.	ANODE	4.	MAIN TERMINAL 2
STYLE 5:		STYLE 6:		STYLE 7:		STYLE 8:	
PIN 1.	GATE	PIN 1.	ANODE	PIN 1.	CATHODE	PIN 1.	CATHODE
2.	DRAIN	2.	CATHODE	2.	ANODE	2.	ANODE
3.	SOURCE	3.	ANODE	3.	CATHODE	3.	EXTERNAL TRIP/DELA
4.	DRAIN	4.	CATHODE	4.	ANODE	4.	ANODE
STYLE 9:		STYLE 10:		STYLE 11:		STYLE 12	:
PIN 1.	GATE	PIN 1.	GATE	PIN 1.	DRAIN	PIN 1.	MAIN TERMINAL 1
2.	COLLECTOR	2.	SOURCE	2.	SOURCE	2.	MAIN TERMINAL 2
3.	EMITTER	3.	DRAIN	3.	GATE	3.	GATE
4.	COLLECTOR	4.	SOURCE	4.	SOURCE	4.	NOT CONNECTED

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